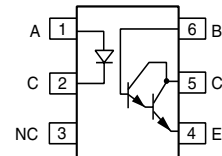
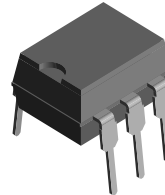


Optocoupler, Photodarlington Output, High Gain, With Base Connection

Features

- Very high current transfer ratio, 500 % Min.
- High isolation resistance, $10^{11} \Omega$ Typical
- Standard plastic DIP package
- Lead-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



Agency Approvals

- UL1577, File No. E52744 System Code H or J, Double Protection
- DIN EN 60747-5-2 (VDE0884)
DIN EN 60747-5-5 pending
Available with Option 1
- BSI IEC60950 IEC60065

1179005



Order Information

| Part | Remarks |
|-----------|-------------------------------|
| 4N32 | CTR > 500 %, DIP-6 |
| 4N33 | CTR > 500 %, DIP-6 |
| 4N32-X007 | CTR > 500 %, SMD-6 (option 7) |
| 4N32-X009 | CTR > 500 %, SMD-6 (option 9) |
| 4N33-X007 | CTR > 500 %, SMD-6 (option 7) |
| 4N33-X009 | CTR > 500 %, SMD-6 (option 9) |

For additional information on the available options refer to Option Information.

Description

The 4N32 and 4N33 are optically coupled isolators with a gallium arsenide infrared LED and a silicon photodarlington sensor.

Switching can be achieved while maintaining a high degree of isolation between driving and load circuits.

These optocouplers can be used to replace reed and mercury relays with advantages of long life, high speed switching and elimination of magnetic fields.

Absolute Maximum Ratings

$T_{amb} = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Stresses in excess of the absolute Maximum Ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute Maximum Rating for extended periods of the time can adversely affect reliability.

Input

| Parameter | Test condition | Symbol | Value | Unit |
|----------------------------|--------------------------|------------|-------|----------------------|
| Peak reverse voltage | | V_R | 3.0 | V |
| Forward continuous current | | I_F | 60 | mA |
| Power dissipation | | P_{diss} | 100 | mW |
| Derate linearly | from 55 $^\circ\text{C}$ | | 1.33 | mW/ $^\circ\text{C}$ |

4N32/ 4N33

| Parameter | Test condition | Symbol | Value | Unit |
|-------------------------------------|----------------|------------|-------|-------|
| Collector-emitter breakdown voltage | | BV_{CEO} | 30 | V |
| Emitter-base breakdown voltage | | BV_{EBO} | 8.0 | V |
| Collector-base breakdown voltage | | BV_{CBO} | 50 | V |
| Emitter-collector breakdown voltage | | BV_{ECO} | 5.0 | V |
| Collector (load) current | | I_C | 125 | mA |
| Power dissipation | | P_{diss} | 150 | mW |
| Derate linearly | | | 2.0 | mW/°C |

Coupler

| Parameter | Test condition | Symbol | Value | Unit |
|--|--|-----------|----------------|-----------|
| Total dissipation | | P_{tot} | 250 | mW |
| Derate linearly | | | 3.3 | mW/° |
| Isolation test voltage (between emitter and detector, Standard Climate: 23 °C/ 50 %RH, \nDIN 500 14) | | V_{ISO} | 5300 | V_{RMS} |
| Leakage Path | | | 7.0 | mm min. |
| Air Path | | | 7.0 | mm min. |
| Isolation Resistance | $V_{IO} = 500 \text{ V}, T_{amb} = 25 \text{ °C}$ | R_{IO} | $\geq 10^{12}$ | Ω |
| | $V_{IO} = 500 \text{ V}, T_{amb} = 100 \text{ °C}$ | R_{IO} | $\geq 10^{11}$ | Ω |
| Storage temperature | | T_{amb} | - 55 to + 150 | °C |
| Operating temperature | | T_{stg} | - 55 to + 100 | °C |
| Lead soldering time | at 260 °C | | 10 | s |

Electrical Characteristics

$T_{amb} = 25 \text{ °C}$, unless otherwise specified

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

Input

| Parameter | Test condition | Symbol | Min | Typ. | Max | Unit |
|-----------------|-----------------------|--------|-----|------|-----|-------|
| Forward voltage | $I_F = 50 \text{ mA}$ | V_F | | 1.25 | 1.5 | V |
| Reverse current | $V_R = 3.0 \text{ V}$ | I_R | | 0.1 | 100 | μ |
| Capacitance | $V_R = 0 \text{ V}$ | C_O | | 25 | | pF |

Output

| Parameter | Test condition | Symbol | Min | Typ. | Max | Unit |
|---|--------------------------------|------------|-----|------|-----|------|
| Collector-emitter breakdown voltage ¹⁾ | $I_C = 100 \mu A, I_F = 0$ | BV_{CEO} | 30 | | | V |
| Collector-base breakdown voltage ¹⁾ | $I_C = 100 \mu A, I_F = 0$ | BV_{CBO} | 50 | | | V |
| Emitter-base breakdown voltage ¹⁾ | $I_C = 100 \mu A, I_F = 0$ | BV_{EBO} | 8.0 | | | V |
| Emitter-collector breakdown voltage ¹⁾ | $I_C = 100 \mu A, I_F = 0$ | BV_{ECO} | 5.0 | 10 | | V |
| Collector-emitter leakage current | $V_{CE} = 10 V, I_F = 0$ | I_{CEO} | | 1.0 | 100 | nA |
| | $I_C = 0.5 mA, V_{CE} = 5.0 V$ | h_{FE} | 13 | | | |

¹⁾ Indicates JEDEC registered values

Coupler

| Parameter | Test condition | Symbol | Min | Typ. | Max | Unit |
|--------------------------------------|----------------|-------------|-----|------|-----|------|
| Collector emitter saturation voltage | | V_{CEsat} | | 1.0 | | V |
| Coupling capacitance | | | | 1.5 | | pF |

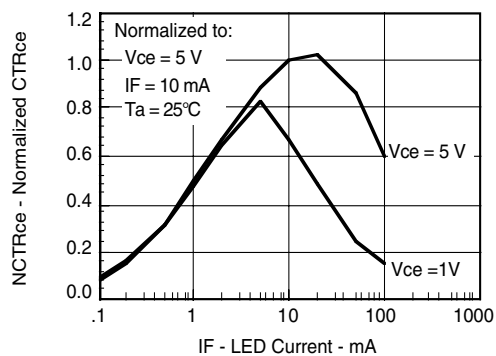
Current Transfer Ratio

| Parameter | Test condition | Symbol | Min | Typ. | Max | Unit |
|------------------------|-------------------------------|--------|-----|------|-----|------|
| Current Transfer Ratio | $V_{CE} = 10 V, I_F = 10 mA,$ | CTR | 500 | | | % |

Switching Characteristics

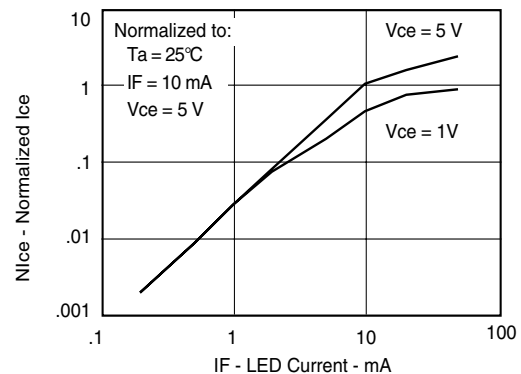
| Parameter | Test condition | Symbol | Min | Typ. | Max | Unit |
|---------------|----------------------------------|-----------|-----|------|-----|---------|
| Turn on time | $V_{CC} = 10 V, I_C = 50 mA$ | t_{on} | | | 5.0 | μs |
| Turn off time | $I_F = 200 mA, R_L = 180 \Omega$ | t_{off} | | | 100 | μs |

Typical Characteristics (Tamb = 25 °C unless otherwise specified)



4n32-33_02

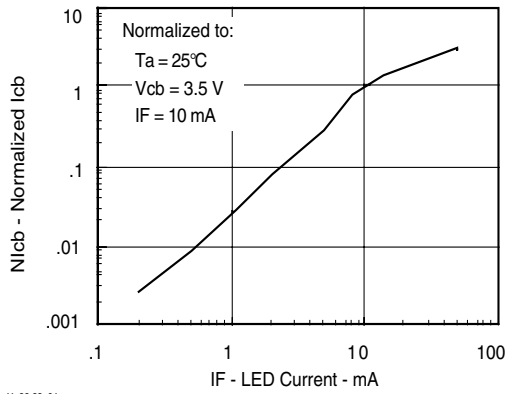
Figure 1. Normalized Non-saturated and Saturated CTR_{CE} vs. LED Current



4n32-33_03

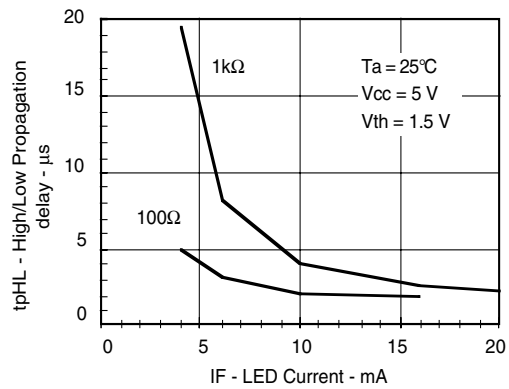
Figure 2. Normalized Non-Saturated and Saturated Collector-Emitter Current vs. LED Current

4N32/ 4N33



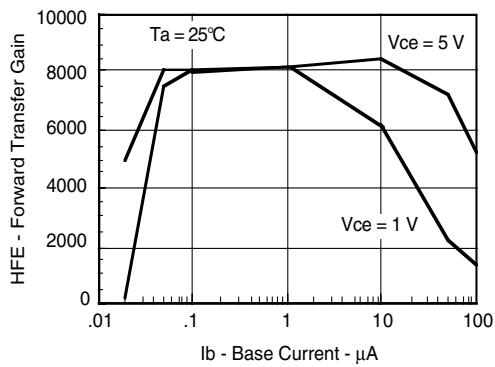
4N32-33_04

Figure 3. Normalized Collector-Base Photocurrent vs. LED Current



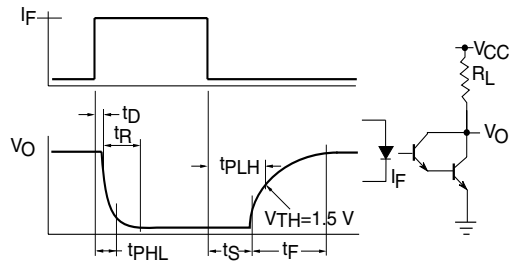
4N32-33_07

Figure 6. High to low Propagation Delay vs. Collector Load Resistance and LED Current



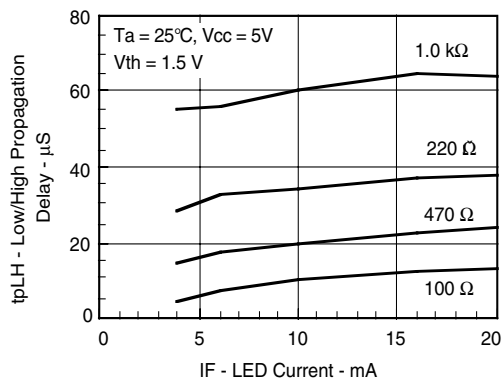
4N32-33_05

Figure 4. Non-Saturated and Saturated HFE vs. Base Current



4N32-33_08

Figure 7. Switching Waveform and Switching Schematic



4N32-33_06

Figure 5. Low to High Propagation Delay vs. Collector Load Resistance and LED Current

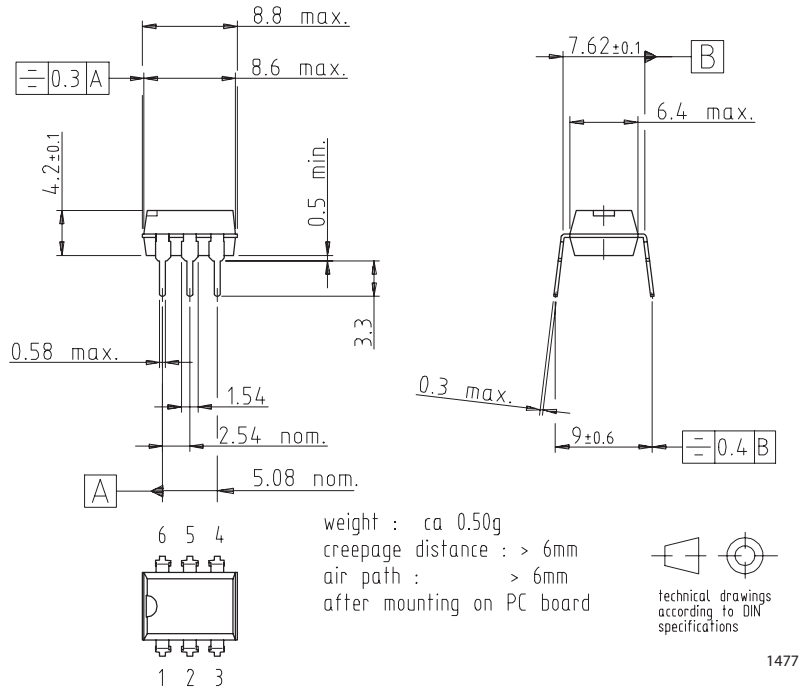
4N32/ 4N33

Package Dimensions in Inches (mm)

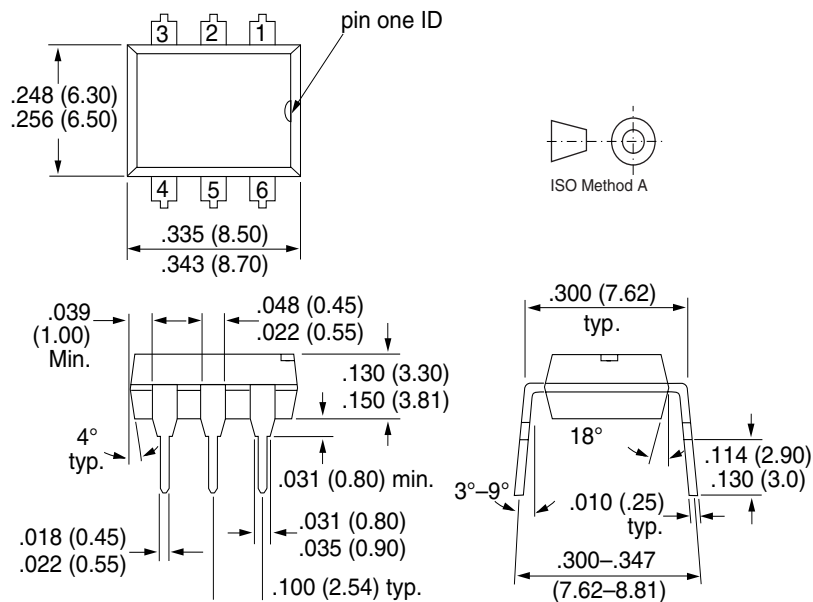
For 4N32/33..... see DIL300-6 Package dimension in the Package Section.

For products with an option designator (e.g. 4N32-X007 or 4N33-X009)..... see DIP-6 Package dimensions in the Package Section.

DIL300-6 Package Dimensions

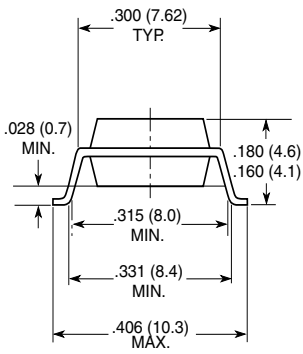


DIP-6 Package Dimensions

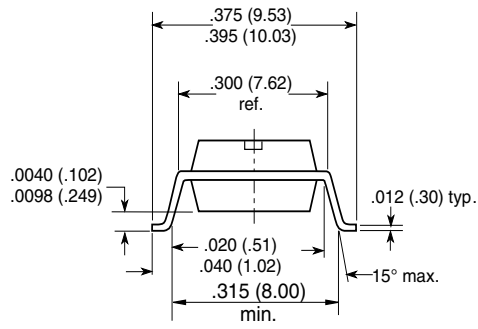


4N32/ 4N33

Option 7



Option 9



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